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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/629,678	07/30/2003	Junji Kunisawa	2003_1074	6560
513	7590 12/07/2005		EXAM	INER
WENDEROTH, LIND & PONACK, L.L.P.			PERRIN, JOSEPH L	
2033 K STREET N. W. SUITE 800			ART UNIT	PAPER NUMBER
WASHINGTO	ON, DC 20006-1021		1746	

DATE MAILED: 12/07/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
	10/629,678	KUNISAWA ET AL.			
Office Action Summary	Examiner	Art Unit			
	Joseph L. Perrin, Ph.D.	1746			
The MAILING DATE of this communication ap Period for Reply	pears on the cover sheet with	the correspondence address			
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING D.  - Extensions of time may be available under the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period.  - Failure to reply within the set or extended period for reply will, by statut. Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNICA 136(a). In no event, however, may a repl will apply and will expire SIX (6) MONTH e, cause the application to become ABAN	TION. y be timely filed S from the mailing date of this communication. IDONED (35 U.S.C. § 133).			
Status					
1) Responsive to communication(s) filed on 04 C	<u> October 2005</u> .				
2a)⊠ This action is FINAL. 2b)☐ This	This action is FINAL. 2b) This action is non-final.				
3) Since this application is in condition for allowa	ance except for formal matters	s, prosecution as to the merits is			
closed in accordance with the practice under	Ex parte Quayle, 1935 C.D. 1	1, 453 O.G. 213.			
Disposition of Claims					
4)⊠ Claim(s) <u>1-8,10-12 and 14-24</u> is/are pending i	n the application.				
4a) Of the above claim(s) is/are withdra	awn from consideration.				
5)⊠ Claim(s) <u>1-8 and 10-12</u> is/are allowed.					
6)⊠ Claim(s) <u>14-24</u> is/are rejected.					
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/o	or election requirement.				
Application Papers		•			
9) The specification is objected to by the Examine	er.				
10) The drawing(s) filed on is/are: a) acc	cepted or b) objected to by	the Examiner.			
Applicant may not request that any objection to the	e drawing(s) be held in abeyance	e. See 37 CFR 1.85(a).			
Replacement drawing sheet(s) including the correct	= : :	•			
11)☐ The oath or declaration is objected to by the E	xaminer. Note the attached C	Office Action or form PTO-152.			
Priority under 35 U.S.C. § 119					
12) ☐ Acknowledgment is made of a claim for foreigr a) ☐ All b) ☐ Some * c) ☐ None of:	n priority under 35 U.S.C. § 1	19(a)-(d) or (f).			
1. Certified copies of the priority document	ts have been received.	·			
2. Certified copies of the priority document	ts have been received in App	lication No			
3. Copies of the certified copies of the price	•	ceived in this National Stage			
application from the International Burea	, , , , , , , , , , , , , , , , , , , ,				
* See the attached detailed Office action for a list	t of the certified copies not re	ceived.			
Attachment(s)					
Notice of References Cited (PTO-892)	4) 🔲 Interview Sum	nmary (PTO-413)			
2) D Notice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/N	fail Date mal Patent Application (PTO-152)			
<ul> <li>Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)</li> <li>Paper No(s)/Mail Date</li> </ul>	6) Other:	mari atent Application (FTO-132)			

#### **DETAILED ACTION**

### Response to Arguments

- Applicant's arguments in view of the amendment of claim 1 with respect to claims
   1-8 have been fully considered and are persuasive. The rejections of claims 1-8 have been withdrawn.
- 2. Applicant's arguments with respect to newly introduced independent claims 14 and 19 have been fully considered but they are not persuasive.
- 3. Specifically, regarding YAMAGATA applicant argues that the opening 103 of YAMAGATA passes through the holder 102 and does not correspond to the claimed hollow section. This is not persuasive because the portion of reference numeral 103 of YAMAGATA passing through holder 102 reads on applicant's hollow section, namely a void, and the portion of reference numeral 103 on the outer periphery of holder 102 reads on an aperture which is fully capable of allowing applicant's claimed intended use of purging a gas into the hollow section. It is noted that applicant's claimed "hollow section defined by said annular vacuum suction member" is significantly broad in scope and offers little structure with respect to the claimed holder other than virtually any void located in and defined by the holder.
- 4. Regarding KINOSHITA, applicant argues that neither of grooves 107 & 108 of KINOSHITA correspond to the claimed hollow section because the hollow section is defined by the annular vacuum suction member, the substrate and the disc-shaped holder plate. Moreover, applicant alleges that KINOSHITA does not disclose an annular

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vacuum suction member. This is not persuasive because the structural portions of KINOSHITA fully anticipate applicant's claimed apparatus. For instance, a careful review of the structure in Figure 20 (and others) shows the structure which reads on applicant's claimed apparatus. Grooves 107/108 clearly function as an "annular vacuum suction member" and the hollow sections between the annular suction members are connected to apertures on both ends of the "hollow sections". In addition, applicant relies on the intended use of whether the holes are for vacuum or gas. As clearly indicated throughout prosecution, in the absence of structural differences the intended use is afforded little weight and the apparatus of KINOSHITA is fully capable of performing said intended use.

5. Regarding WATANABE, applicant argues that WATANABE does not disclose the features of claims 14 & 19. However, since WATANABE is cited as a secondary reference (i.e. not solely relied upon for an anticipatory rejection) further discussion of WATANABE is not deemed necessary.

#### Claim Rejections - 35 USC § 112

- 6. The following is a quotation of the second paragraph of 35 U.S.C. 112:

  The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 7. Claims 15 & 22 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention. A material having a hardness that is lower than that of the substrate is indefinite since such material is wholly dependent on the unclaimed

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hardness and material of which the substrate is composed. Therefore, the metes and bounds of patent protection sought cannot be determined. Clarification and correction are required.

## Claim Rejections - 35 USC § 102

- 8. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.
- 9. Claims 14-17, 19-20 & 22-24 are rejected under 35 U.S.C. 102(b) as being anticipated by U.S. Patent No. 5,951,833 to YAMAGATA. Re claim 14, YAMAGATA discloses a substrate holding unit with a holding plate (102) having an aperture (opening 103) and vacuum suction members (O-rings 104) contacting only the outer periphery of the substrate (101), thereby defining "a space" sealed from one side of the substrate (see, for instance, col. 10, line 54 - col. 11, line 30; Figure 1). Re claim 5, YAMAGATA further discloses the holding unit in combination with a surface processing unit (anodizing apparatus, see, col. 2, line 56 et seg.). Re claim 19, YAMAGATA further discloses using a dipping bath (see, col. 7, line 21, as well as Figure 1 and relative associated text). It is noted that applicant's recitation of purging gas is considered intended use and given little weight. That is, recitations that the purging aperture is "for purging a gas into a hollow space" and the gas being N<sub>2</sub> and the bath liquid being an etchant do not positively recite structure requiring N<sub>2</sub> or an etchant. A recitation of the intended use of the claimed invention must result in a structural difference between the claimed invention and the prior art in order to patentably distinguish the claimed

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invention from the prior art. If the prior art structure is capable of performing the intended use, then it meets the claim. See *In re Casey*, 370 F.2d 576, 152 USPQ 235 (CCPA 1967) and *In re Otto*, 312 F.2d 937, 939, 136 USPQ 458, 459 (CCPA 1963). Recitation of YAMAGATA reads on applicant's claimed invention. Regarding the member being a resilient material having a hardness lower than the substrate, such as natural rubber, etc., YAMAGATA clearly discloses using rubber when contacting the substrate (for instance, col. 11, line 37). Furthermore, it is well within the knowledge of one having ordinary skill in the art that conventional o-rings are composed of rubber. Claims 14-17 are rejected under 35 U.S.C. 102(b) as being anticipated by US 10. 5,534,073 to KINOSHITA et al. (hereinafter "KINOSHITA"). Re claim 1, KINOSHITA discloses a wafer holding unit comprising an holder plate (101) and an outer peripheral vacuum suction member defined by two annular grooves (107) formed by at least two ring-shaped members, apertures (113/108) and the vacuum chuck device having a purging aperture ("holes of a vacuum chuck are provided corresponding to holes of a gas nozzle provided at a position making a pair with the vacuum chuck", see, for instance, col. 8, lines 47-51 of Kinoshita et al.) (see also Figures 11-18 and relative associated text). Re claim 5, KINOSHITA discloses a semiconductor processing (producing) device having the wafer chucking (holding) device and surface processing unit (CVD device), and cleaning (for instance, col. 1, lines 9-18). Re claims 15-17. KINOSHITA further discloses the well known practice of using rubber o-rings as vacuum seals (col 5, lines 40-44).

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# Claim Rejections - 35 USC § 103

11. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

Claims 18-24 are rejected under 35 U.S.C. 103(a) as being unpatentable over 12. KINOSHITA in view of U.S. Patent No. 5,025,280 to LAMB et al. (hereinafter "LAMB"). Recitation of KINOSHITA is repeated here from above. Although KINOSHITA discloses a vacuum chuck in a surface processing unit for CVD and cleaning, KINOSHITA does not expressly disclose a rotary vacuum chuck and a dipping bath for cleaning. LAMB teaches that it is known to utilize a rotary vacuum wafer holding unit as a part of a processing apparatus (30) with a dipping bath (24) to rotate and move a horizontal wafer via a cylinder portion of the vacuum chuck for cleaning wafers (see entire reference of LAMB, for instance, Figure 1 and col. 4, lines 8-17). The position is taken that a person of ordinary skill in the art at the time the invention was made would have been motivated to substitute one known vacuum chuck for another in a wafer processing apparatus including a vacuum wafer holding unit in order to provide optimal processing and cleaning of a semiconductor. Moreover, there would be a reasonable expectation of success in substituting one known vacuum chuck for another known vacuum chuck in the semiconductor processing art, both references being analogous art in the semiconductor art.

#### Allowable Subject Matter

13. Claims 1-8 & 10-12 are allowed.

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## Conclusion

14. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

- 15. A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.
- 16. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Joseph L. Perrin, Ph.D. whose telephone number is (571)272-1305. The examiner can normally be reached on M-F 7:00-4:30, except alternate Fridays.
- 17. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael E. Barr can be reached on (571)272-1414. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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18. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

and the

Joseph L. Perrin, Ph.D. Primary Examiner Art Unit 1746

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